

2.8X0.8mm RIGHT ANGLE SMD CHIP LED LAMP

Features

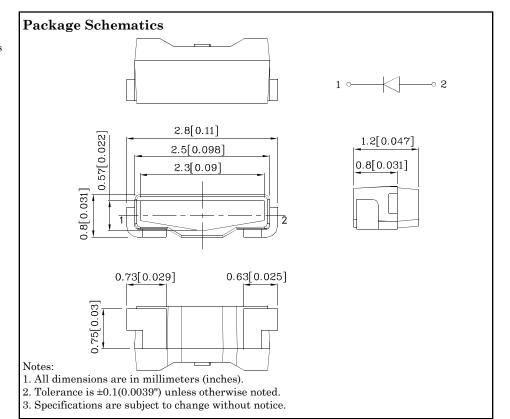
- \bullet Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- \bullet MSL (Moisture Sensitivity Level): 3
- RoHS compliant







ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



Absolute Maximum Rating (TA=25°C)	FWS (InGaN)	Unit		
Reverse Voltage	$V_{\rm R}$	5	V	
Forward Current	I_{F}	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	100	mA	
Power Dissipation	P_{D}	120	mW	
Operating Temperature	T_{A}	-40 ~ +85	°C	
Storage Temperature	Tstg	Tstg -40 ~ +85		
Electrostatic Discharge Thresh (HBM)	250	V		

Operating Characteristics (T _A =25°C)		FWS (InGaN)	Unit
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	3.3	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	4	V
Reverse Current (Max.) $(V_R=5V)$	I_R	50	uA
Chromaticity Coordinates	X	0.31	
(Typ.)	у	0.31	
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	100	pF

 Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous Intensity} \\ \text{CIE127-2007*} \\ \text{(I_F=20mA)} \\ \text{mcd} \end{array}$		Viewing Angle 20 1/2
				min.	typ.	
XZFWS81FS	White	InGaN	Water Clear	1000*	1395*	110°

^{*}Luminous intensity value is in accordance with CIE127-2007 standards.

Feb 20,2014



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Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

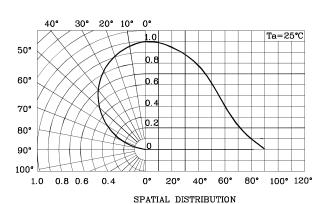
1.Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



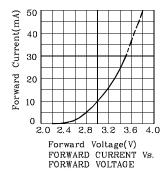
2. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

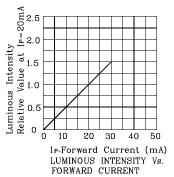
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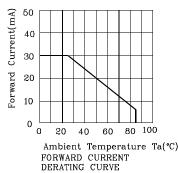


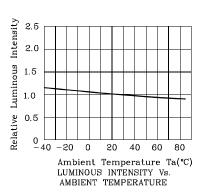


❖ FWS



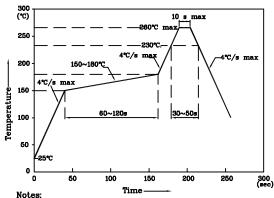






LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

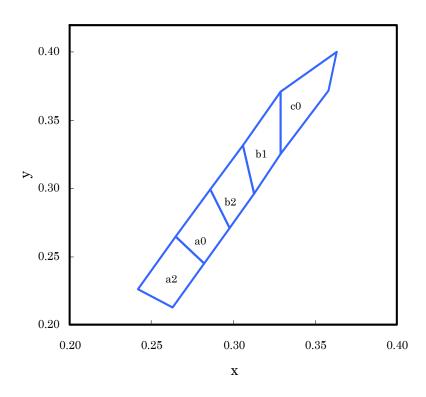


- Notes:
 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions



XZFWS81FS

White CIE



	X	у		X	У		X	у
	0.263	0.213	а0	0.282	0.245	b2	0.298	0.271
a2	0.282	0.245		0.298	0.271		0.313	0.296
	0.265	0.265		0.286	0.299		0.306	0.332
	0.242	0.226		0.265	0.265		0.286	0.299
	0.313	0.296	c0	0.329	0.325			
b1	0.329	0.325		0.358	0.372			
01	0.329	0.371		0.363	0.400			
	0.306	0.332		0.329	0.371			

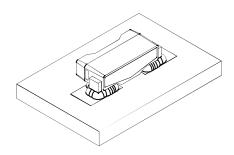
Notes

Shipment may contain more than one chromaticity regions. Orders for single chromaticity region are generally not accepted. Measurement tolerance of the chromaticity coordinates is ± 0.01 .

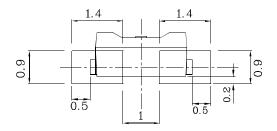




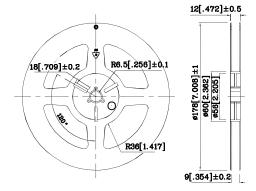
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



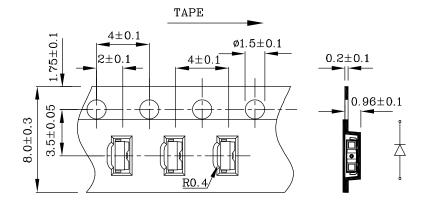
♦ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



❖ Reel Dimension



❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity/ luminous flux or chromaticity), the typical accuracy of the sorting process is as follows:

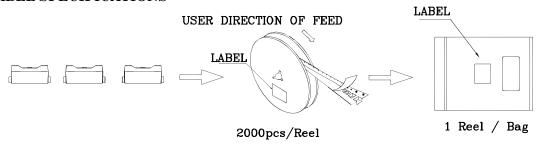
- 1. Measurement tolerance of the chromaticity coordinates is ± 0.01 .
- 2. Luminous Intensity/ Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

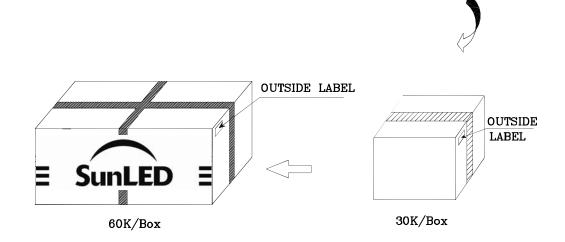
Note: Accuracy may depend on the sorting parameters.

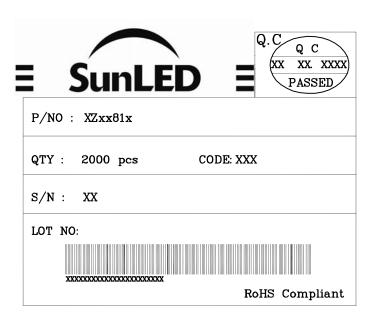




PACKING & LABEL SPECIFICATIONS







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